## Operation Procedure for EVAP1 CHA Solution E-Beam Evaporator

## Start-Up and Loading

- 1. Initial State: Touch screen should indicate system is in automatic mode and should read "Pump Down Complete" unless another user just finished using it
- 2. Vent Chamber to load samples and source metals
  - a. Press F5 "Standby" on touch screen
  - b. Press Auto Tree" on touch screen
  - c. Press F3 "Auto Vent" on touch screen
  - d. Press "Yes" to vent
- 3. After venting is complete, press "Release Latch" to open the chamber door
- 4. Clean (vacuum) inside of chamber if necessary
- 5. Contact SMiF staff if crystal replacement is necessary (at ~70% crystal health)
- 6. Load or replenish source metals as necessary
  - a. Load metal sources ONLY in the pocket locations indicated in the chart posted beside the evaporator
- 7. Load substrates in the dome, using the jog button on the touch screen to rotate the dome
- 8. Before closing the door:
  - a. Verify gun rotation (using touch screen)
  - b. Verify all metals are in correct pocket locations
  - c. Verify shutter operation (using shutter button on Maxtek MDC-360) and leave shutter closed
  - d. Verify the mirrors are centered left to right in the window
- 9. Close the chamber door and press "Close Latch" on the touch screen
- 10. Press "Standby" on the touch screen
- 11. Press "Auto Tree" on the touch screen
- 12. Press F2 "Auto Pump" on the touch screen
- 13. Verify that pump sequence switches over to IG2 (chamber pressure reading) after a few minutes.
  - a. If IG2 switch over fails, wait a minute and then manually press the IG2 button
  - b. System will indicate pump complete when IG2 setpoint 1 is reached (1E-5)
- 14. The water flow to the system is now always kept on, so it is not user adjustable
- 15. Turn the key to the "On" position on the High Voltage module
- 16. Turn the power on to the high voltage power supply
- 17. Verify that all green lights are illuminated on the top row of the High Voltage and Gun Control modules

## Processing (Metal Deposition)

- 18. Create or revise desired process on the Maxtek MDC-360 (if needed)
- 19. Verify process materials and target thicknesses in desired process program
- 20. Press Start on the Maxtek MDC-360
  - a. Move cursor to the desired process
  - b. Press Start again
    - i. System should move to pocket location of first metal
    - ii. Confirm system states "soak rise"
- 21. Press Abort and then Reset on the Maxtek MDC-360
  - a. Maxtek screen should indicate "Process Ready"

- 22. Wait until desired chamber vacuum level is achieved and then press F1 "Auto Run" on the touch screen to start the deposition process.
  - Note: Deposition process will not start until IG2 setpoint 2 is reached (5E-6)
- 23. When Auto run is started, the following should occur:
  - a. High voltage module is turned on and voltage reads 10kVb. Gun control module is turned on
  - c. Maxtek program is started with first metal going into "soak rise"
- 24. Verify fixture rotation is 20 rpm on touch screen
- 25. As beam current ramps up, observe beam location and sweep amplitude and adjust if necessary according to following diagrams:

Beam path should form a figure 8 in the size indicated relative to the metal source size



Do not adjust the sweep frequency

26. Fill out a run sheet in the logbook during the deposition process

## **Unloading and Shut-down**

- 27. When the deposition process has been completed, the touch screen will display "Do you want to vent?"
- 28. Press "Yes" on the touch screen to vent the system
- 29. After venting is complete, press "Release Latch" to open the chamber door
- 30. Unload substrates from the dome, using the jog button on the touch screen to rotate the dome
- 31. Clean (vacuum) inside of chamber if necessary
  - a. If Co or Ni were used, you must remove the sources when complete and clean the pockets and chamber thoroughly
  - b. The cryopump gate port (under the screen at the right front of the chamber) must be vacuumed after every run
- 32. Close the chamber door and press "Close Latch" on the touch screen
- 33. Press "Standby" on the touch screen
- 34. Press "Auto Tree" on the touch screen
- 35. Press F2 "Auto Pump" on the touch screen
- 36. Verify that pump sequence switches over to IG2 (chamber pressure reading) after a few minutes.
  - a. If IG2 switch over fails, wait a minute and then manually press the IG2 button
- 37. Turn the key to the "Off" position on the High Voltage module
- 38. Turn the power off to the high voltage power supply
- 39. Complete any entries on run sheet in logbook